

HI1177

8-Bit, 40MSPS, 2-Channel D/A Converter

FN4114 Rev 2.00 January 1999

The HI1177 is a dual 8-bit CMOS digital-to-analog converter. It has input/output equivalent to 2 channels of Y and C for video use or I and Q for modulators.

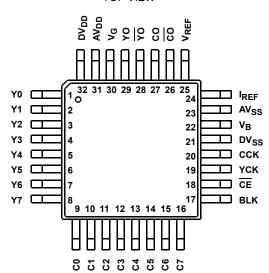
The HI1177 is available in the industrial temperature range and is supplied in a 32 lead plastic metric quad flatpack (MQFP) package.

Ordering Information

PART NUMBER	TEMP. RANGE (°C)		
HI1177JCQ	-40 to 85	32 Ld MQFP	Q32.7x7-S

Pinout

HI1177 (MQFP) TOP VIEW



Features

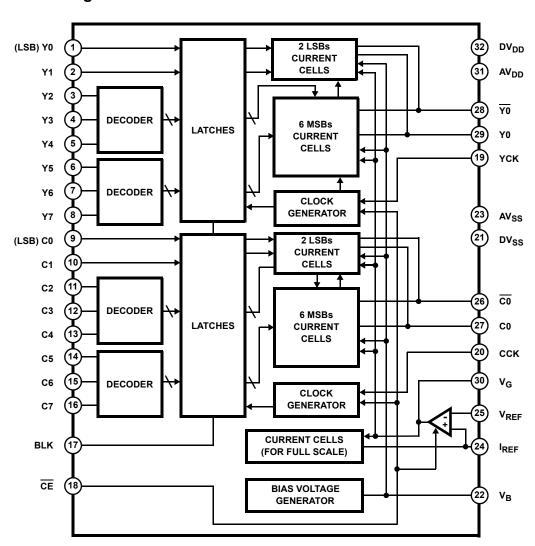
• Resolution 8-Bit
Maximum Conversion Speed 40MHz
YC 2-Channel Input/Output
Differential Linearity Error ±0.3 LSB
Low Power Consumption
• Power Supply +5V Single
Power-Down Mode

- · Low Glitch Noise
- Direct Replacement for Sony CXD1177

Applications

- I/Q Modulation
- YC Video
- · Digital TV
- · Wireless Transmitters

Functional Block Diagram



Pin Descriptions

NUMBER	SYMBOL	EQUIVALENT CIRCUIT	DESCRIPTION
1 to 8	Y0 to Y7	φ DV _{DD}	Digital Input.
9 to 16	C0 to C7	1 DV _{SS}	
17	BLK	17 DV _{DD} DV _{SS}	Blanking Pin. No signal at "H" (Output 0V). Output condition at "L".

Pin Descriptions (Continued)

NUMBER	SYMBOL	EQUIVALENT CIRCUIT	DESCRIPTION			
22	V _B	DV _{DD} DV _{DD} 22 DV _{SS}	Connect a capacitor of about 0.1μF.			
19	YCK	Ŷ DV _{DD}	Clock Pin. Moreover all input pins are			
20	CLK	19 DV _{SS}	TTL-CMOS compatible.			
21	DV _{SS}		Digital GND.			
23	AV _{SS}		Analog GND.			
18	CE	18 DV _{SS}	Chip Enable Pin. No signal (Output 0V) at "H" and minimizes power consumption.			
24	I _{REF}	AV _{DD} Q AV _{DD}	Connect a resistance 16 times "16R" that of output resistance value "R".			
25	V_{REF}	Ĭ Ţ	Set full scale output value.			
30	V_{G}	AV _{DD} Q ⁽²⁴⁾	Connect a capacitor of about 0.1µF.			
31	AV _{DD}	AV _{SS} AV _{DD} AV _{DD} AV _{SS}	Analog V _{DD} .			
27	СО	AV _{DD} γ ι	Current Output Pin. Voltage output can be			
29	YO	1	obtained by connecting a resistance.			
26	CO		Inverted Current Output Pin. Normally			
28	ΫŌ	AV _{SS} AV _{SS} AV _{SS}	dropped to analog GND.			
32	DV_DD		Digital V _{DD} .			

Absolute Maximum Ratings $T_A = 25^{\circ}C$

Supply Voltage, V _{DD}	.7V
Input Voltage, V _{IN}	ss/
Output Current (For Each Channel), I _{OUT} 0mA to 15	mΑ

Operating Conditions

-
Supply Voltage
AV _{DD} , AV _{SS} 4.75V to 5.25V
DV _{DD} , DV _{SS}
Reference Input Voltage, V _{REF}
Clock Pulse Width
t _{PW1}
t _{PW0}
Temperature Range, T _{OPB} 40°C to 85°C

Thermal Information

Thermal Resistance (Typical, Note 7)	θ_{JA} (°C/W)
MQFP Package	122
Maximum Junction Temperature (Plastic Package)	
Maximum Storage Temperature Range65	^o C to 150 ^o C
Maximum Lead Temperature (Soldering 10s)	300°C
(MQFP - Lead Tips Only)	

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. $\theta_{\mbox{\scriptsize JA}}$ is measured with the component mounted on an evaluation PC board in free air.

$\textbf{Electrical Specifications} \quad \text{f_{CLK} = 40MHz, V_{DD} = 5V, R_{OUT} = 200Ω, V_{REF} = $2.0V$, T_{A} = $25^{\circ}C$}$

PARA	METER	SYMBOL	TEST CONDITIONS	TEST LEVEL OR NOTES	MIN	TYP	MAX	UNITS
Resolution		n			-	8	-	bit
Maximum Conve	ersion Speed	f _{MAX}			40	-	-	MHz
Linearity Error		EL			-2.5	-	2.5	LSB
Differential Linea	arity Error	ED			-0.3	-	0.3	LSB
Full Scale Output Voltage		V _{FS}			1.9	2.0	2.2	V
Full Scale Output Ratio		F _{SR}		Note 1	0	1.5	3	%
Full Scale Output	t Current	I _{FS}			-	10	15	mA
Offset Output Voltage		Vos			-	-	1	mV
Power Supply Current		I _{DD}	14.3MHz, at Color Bar Data Input		-	-	32	mA
Digital Input High Level		I _{IH}			-	-	5	μА
Current	Low Level	I _{IL}			-5	-	-	μА
Setup Time		t _S			5	-	-	ns
Hold Time		t _H			10	-	-	ns
Propagation Delay Time		t _{PD}			-	10	-	ns
Glitch Energy		GE	R _{OUT} = 75Ω		-	30	-	pV-s
Cross Talk		СТ	1MHz Sin Wave Output		-	57	-	dB

NOTE:

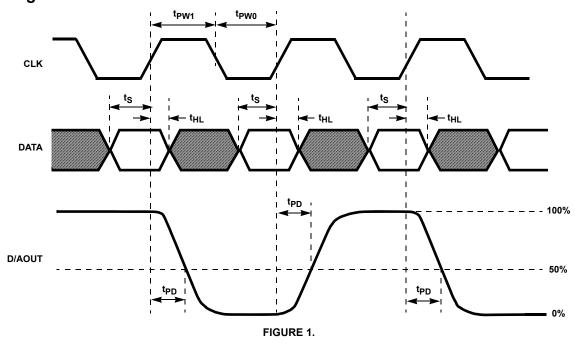
1. Full scale output ratio = $\frac{\text{Full-scale voltage of channel}}{\text{Average of the full-scale voltage of the channels}} (-1) x 100 (%).$

I/O Correspondence Table (Output Full Scale Voltage: 2V)

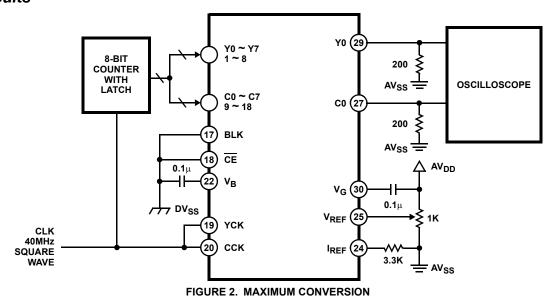
	INPUT CODE						OUTPUT VOLTAGE	
MS	В					LS	BB	
1	1	1	1	1	1	1	1	2.0V
				•				
				•				
1	0	0	0	0	0	0	0	1.0V
'	U	U	U		U	U	U	1.00
				•				
0	0	0	0	0	0	0	0	0V



Timing Diagram



Test Circuits



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Test Circuits (Continued)

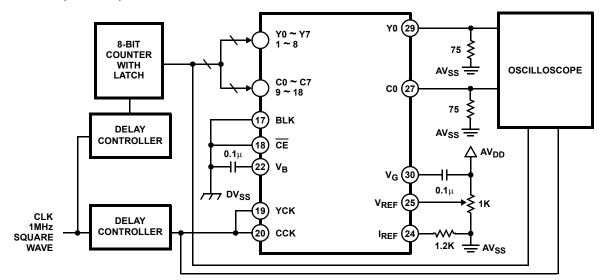


FIGURE 3. SETUP HOLD TIME AND GLITCH ENERGY

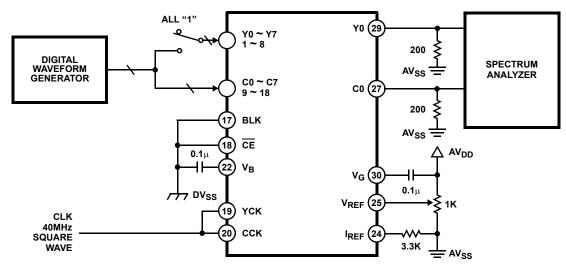


FIGURE 4. CROSSTALK

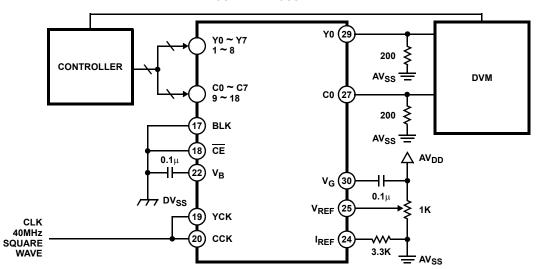


FIGURE 5. DC CHARACTERISTICS

Test Circuits (Continued)

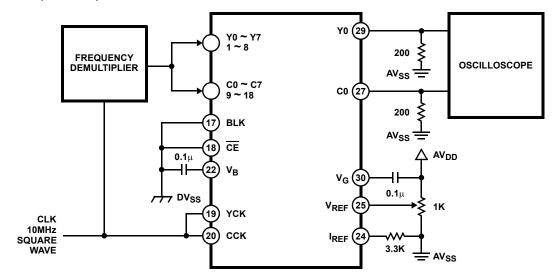


FIGURE 6. PROPAGATION DELAY TIME

Typical Performance Curves

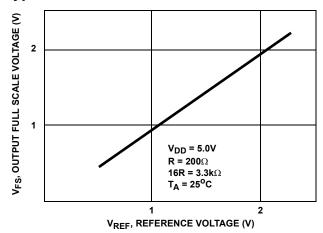


FIGURE 7. OUTPUT FULL SCALE VOLTAGE vs REFERENCE VOLTAGE

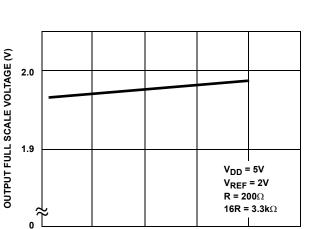


FIGURE 9. OUTPUT FULL SCALE VOLTAGE vs AMBIENT TEMPERATURE

AMBIENT TEMPERATURE (°C)

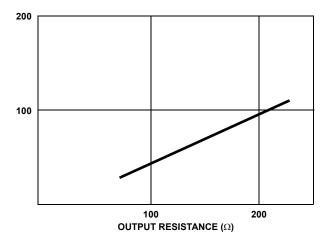


FIGURE 8. GLITCH ENERGY vs OUTPUT RESISTANCE

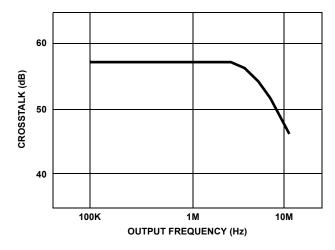


FIGURE 10. CROSSTALK vs OUTPUT FREQUENCY

100

75

-25

Application Circuit

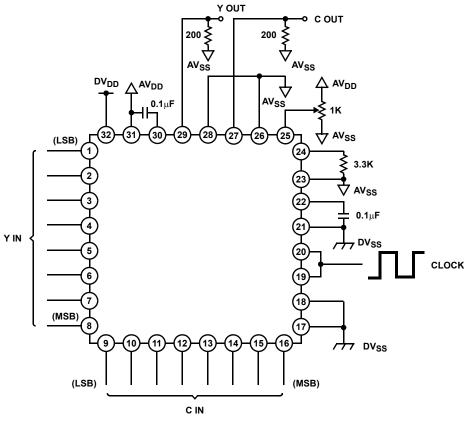


FIGURE 11.

Operation

- How to select the output resistance:
 - The HI1177 is a D/A converter of the current output type. To obtain the output voltage connect the resistance to IO pin (Y0, C0). For specifications we have:

Output full scale voltage V_{FS} = less than 2V Output full scale current I_{FS} = less than 15mA

- Calculate the output resistance value from the relation of $V_{FS} = I_{FS} \ X \ R$. Also, 16 times resistance of the output resistance is connected to reference current pin I_{REF} . In some cases, however, this turns out to be a value that does not actually exist. In such a case a value close to it can be used as a substitute. Here please note that V_{FS} becomes $V_{FS} = V_{REF} \ X \ 16R/R'$. R is the resistance connected to IO while R' is connected to I_{REF} . Increasing the resistance value can curb power consumption. On the other hand glitch energy and data settling time will inversely increase. Set the most suitable value according to the desired application.

- Phase relation between data and clock:
 - To obtain the expected performance as a D/A converter, it is necessary to set properly the phase relation between data and clock applied from the exterior. Be sure to satisfy the provisions of the set up time (t_S) and hold time (t_H) as stipulated in the Electrical Characteristics.
- V_{DD}, V_{SS}:
 - To reduce noise effects separate analog and digital systems in the device periphery. For V_{DD} pins, both digital and analog, bypass respective GNDs by using a ceramic capacitor of about 0.1μF, as close as possible to the pin.